

Website: www.displaytech.com.hk

LCD Module Product Specification

Product: 32128A Series Monochrome Graphic Display Module (128x32DOTS)

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1. REVISION RECORD

VERSION	CHANGES	DATE
1.0	Initial revision	17 Feb. 2006
1.1	Wide temperature range in page 2	27 Mar. 2006
1.2	Maximum power supply for logic at absolute maximum ratings in page 2	15 Apr. 2008
2.0	New format; Changed the LED driving current on page 5, 6, & 7.	Jan 30, 2013
2.1	Add interface info in 2. General Specifications	Oct 28, 2014

LCD MODULE

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2. General Specifications

Item	Contents
Display Format	128 x 32 DOTS
Dot Size	0.242 x 0.245
View Area	36.1 mm x 9.95mm
Module Size	41.3 mm x 19.7mm x 8.1 mm
LCD Type	FSTN
Polarizer Mode	Transflective
View Angle	6 O'clock
Backlight	LED
Backlight Driver Type	External Power
Backlight Color	White
Controller & LCD Driver	ST7565V
Driving Method	1/33 Duty, 1/6 Bias
Interface	8-Bit Parallel

3. Absolute Maximum Ratings

(Ta=25°C, VSS=0V)

ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT
Power Supply for Logic	VDD	-0.3		3.6	V
Power Supply for LCD	V0-VSS	4.0		13.0	V
Input Voltage	V_{IN}	-0.3		VDD+0.3	V
Supply Voltage for LED Backlight	$V_{ m LED}$		3.2		V
Normal Operating Temperature	Top	0		50	°C
Normal Storage Temperature	Tst	-10		60	°C
Wide Operating Temperature	Тор	-20		70	°C
Wide Storage Temperature	Tst	-30		80	°C

Note:

- When temperature is below 0°C, the response time of liquid crystal (LC) will be slower.
- If module driving condition exceeds the absolute maximum ratings, permanent damaged may be resulted. If module is driven within the absolute maximum ratings but exceeded the DC characteristics, malfunction may be resulted.
- VDD/VCC > VSS

4. Electrical Characteristics

DC Characteristics

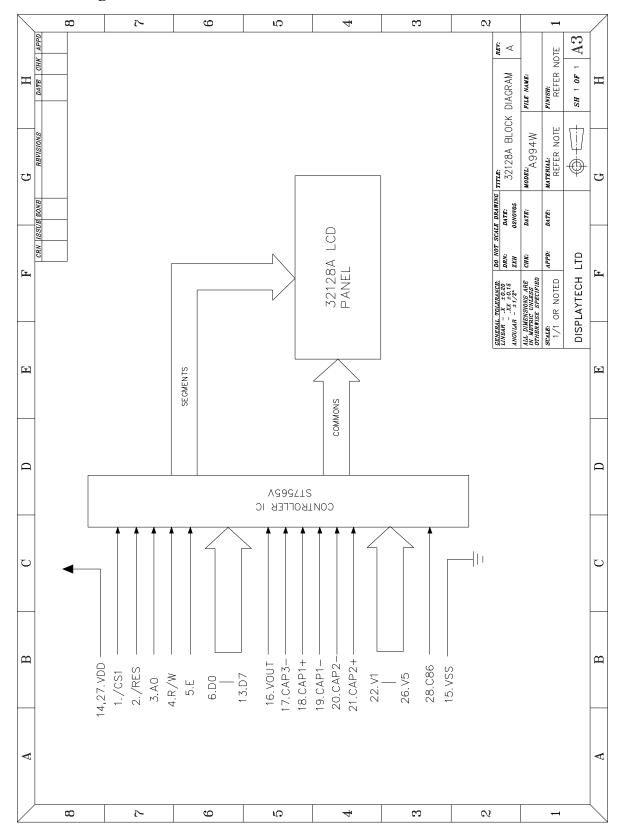
(Ta=25°C, VSS=0V)

ITEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
Power Supply for LCM VDD			2.85	3.0	3.15	Volt
Innut Voltage	$V_{ m IL}$	L level	Vss		0.2VDD	Volt
Input Voltage	$ m V_{IH}$	H level	0.8VDD		Vdd	Volt
I CD Duixron Duixrin a						
LCD Driver Driving Voltage	VDD2	25°C		6.9		Volt
Voltage						
Supply Current for	IDD	VDD=3.0V; 25°C		0.35		mA
LCM	ILED	VLED=3.2V; 25°C		45	60	шА

5. Display Controller /Power Supply Timing

See Display Controller Specification: Sitronix ST7565V

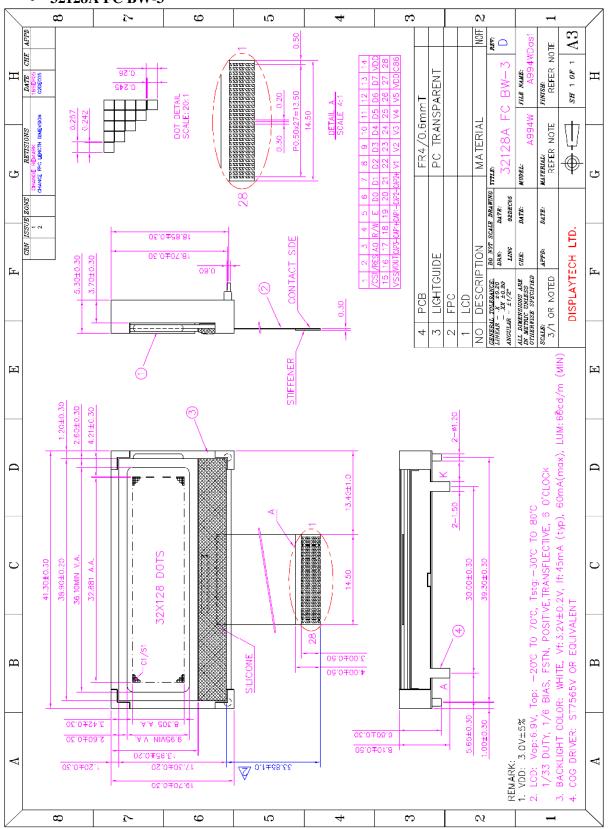
6. Block Diagram



LCD MODULE

7. Mechanical Drawing

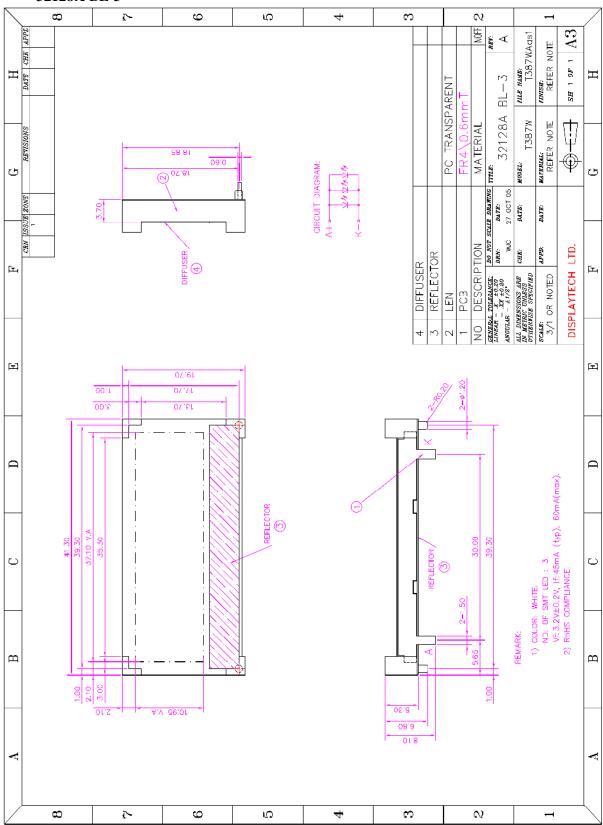
32128A FC BW-3



LCD MODULE

8. Backlight Drawing

32128A BL-3



9. Backlight specification

• MECHANICAL SPECIFICATIONS

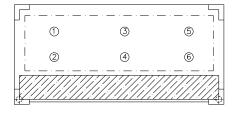
ITEM	NOMINAL DIMENSIONS	UNIT
OUTLINE SIZE (LxWxH)	41.3 x 19.7 x 8.10	mm
VIEWING AREA (LxW)	37.10 x 10.95	mm
CONTACT PIN PITCH/LENGTH	NIL	mm
NO.OF LED SMT	3	

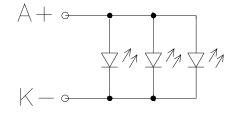
• ELECTRICAL/OPTICAL CHARACTERISTICS (Ta=25°C, If=45mA typ.)

MODE	PARAN	UNIT	
COLOR	WH		
CHROMATICITY COORDINATE	X=0.3105	Y=0.3323	
AVERAGE LUMINOUS INTENSITY (IV)	42	cd/m ²	
FORWARD VOLTAGE (Vf)	3.2	V	

• ABSOLUTE MAXIMUM RATING

ITEM	VALUE	UNIT
FORWARD CURRENT	60mA	If
REVERSE VOLTAGE	5V	Vr
OPERATING TEMPERATURE	-20°C TO 70°C	Top
STORAGE TEMPERATURE	-30°C TO 80°C	Tstg





TESTING POINT

CIRCUIT DIAGRAM

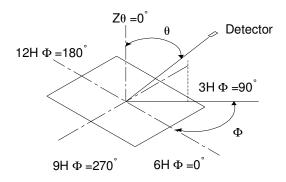
REMARK:

- 1. Average luminous intensity is the average value of the six indicated points as shown.
- 2. Measurement instrument: BM-7, APERTURE: Ø10mm.
- 3. IT IS RECOMMENDED TO DRIVE THE LED BACKLIGHT WITH PWM SIGNAL.

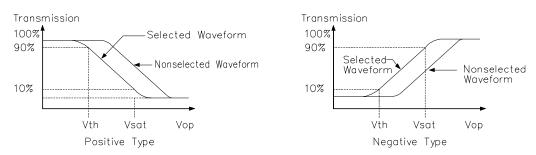
10. Optical Characteristics

NO	Técana	Cross b ol	Measuring		STD.	Value		Unit	Remark	
NO	Item	Symbol	Condition	°C	Min	Тур	Max	Ullit	Kemark	
1	Recommended Operating Voltage	VLCD	$\theta = 0$ $\Phi = 0$	25	6.6	6.9	7.2			
			$\theta = 0$	0					NI -4 - 1	
		Vth	$\Phi = 0$	25		1.889		V	Note1 Note2	
2	Operating		Φ= 0	50					Note2	
2	Voltage		$\theta = 0$	0						
		Vs	Vsat	$\Phi = 0$	25		2.116			
			Ψ= 0	50						
		Tr $\theta = 0$ $\Phi = 10$	0 - 0	0				ms	Note4	
			- "	25		58	90			
3	Daamanaa tima			50						
3	Response time		Tf $\theta = 0$ $\Phi = 10$	0						
		Tf		25		118	210			
			Ψ= 10	50						
		θ	Ф=0°	25		40				
4	Viewing	θ	Ф=180°	25		35		Dog	Note1	
4	Angle ($Cr \ge 2$)	θ	Ф=90°	25		30		Deg	Note1	
		θ	Ф=270°	25		30				
5	Current Consumption	ILCD	Hz=64	25		17		uA	Note3	

NOTE 1: DEFINITION OF VIEWING ANGLE AND DIRECTION



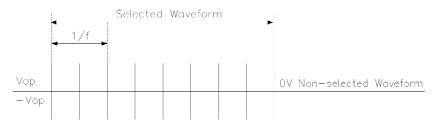
NOTE 2: THERSHOLD VOLTAGE AND SATURATION VOLTAGE



Vth: The voltage Vop which the transmission rate of segment is 90%(positive) or 10%(negative) of saturated value on conditions of the selected waveform.(non-selected waveform is opposition)

Vsat: The voltage Vop which the transmission rate of segment is 10%(positive) or 10%(negative) of saturated value on conditions of the selected waveform.(non-selected waveform is opposition)

NOTE 3: CURRENT CONSUMPTION (I LCD)

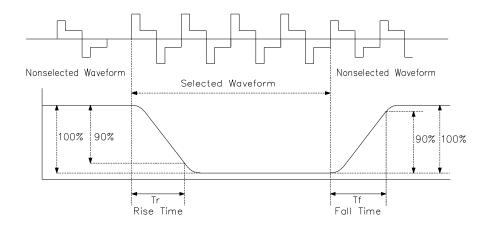


Conditions:

1. Driving waveform: static waveform.

2. Voltage applied to all segments

NOTE 4: RESPONSE TIME (Tr, Tf)



NOTE 5: CONTRAST RATIO (CR)

5.1 POSITIVE TYPE:

CONTRAST RATIO = BRIGHTNESS AT VOP(NON-SELECTED)

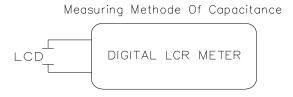
BRIGHTNESS AT VOP(SELECTED)

5.2 NEGATIVE TYPE:

CONTRAST RATIO = BRIGHTNESS AT VOP(SELECTED)

BRIGHTNESS AT VOP(NON-SELECTED)

NOTE 6: CAPACITANCE (C)



Conditions:

Voltage applied to all segments.

11.Quality Guarantee

• PURPOSE: It is to define the inspection standard of LCD modules

• PRODUCT STANDARD

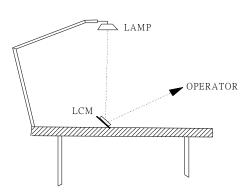
- 1) INSPECTION AND TEST
 - FUNCTION TEST
 - APPEARANCE INSPECTION
 - PACKING SPECIFICTION

2) INSPECTION CONDITION

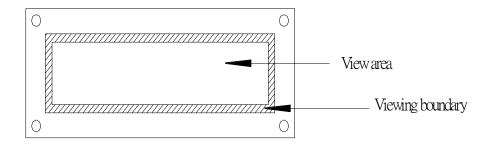
- Put under the lamp (20w×2) at a distance 100mm from the LCD Modules.
- Tilt upright 45 degree by the front (back) to inspect LCD appearance.

3) AQL INSPECTION LEVEL

SAMPLING METHOD : MIL-STD-105D
 SAMPLING PLAN : SINGLE
 MAJOR DEFECT : 0.65% (MAJOR)
 MINOR DEFECT : 2.5% (MINOR)
 GENERAL LEVEL : II/NORMAL



• DISPLAY AREA DEFINITION:



• INSPECTION STANDARD

1) FUNCTIONAL TEST STANDARD

LCD has no display LCM display do not change Display wrong pattern							d Reject	type				
LCM display do not change Display wrong pattern					LCD has no display							
3 Display wrong pattern												
. ,							Reject Reject	MAJ MAJ				
4 Display segment open	Missing segment Missing segment Missing segment					Reject	MAJ					
5 Display dim segment	Display dim segment Dim segment Dim segment						Reject	MAJ				
6 Wrong LCD viewing direct	ion						Reject	MAJ				
7 Dim Display							See sample	MAJ				
8 LCD color variation							See sample	MAJ				
Pattern parallelism			A	cceptable								
		L 20		<a< td=""><td></td><td>b</td><td></td><td></td></a<>		b						
		≥20m ≥30m		10.43°		15mm						
						2mm						
	$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$						Accept					
9 9 9 9 9 9 9 9 9 9												
	Ζά -			1 0.43°	-		-					
			m	$ 0.41^{\circ} \leq 0.50 \text{mm}$ $ 0.43^{\circ} \leq 0.60 \text{mm}$								
<u> </u>	-	≥80m		1 0.43°								
		≥90m		0.41°	•	55mm						
		≥100m	nm	1 0.43°		75mm						
					andard							
	×		Ø=	$=\frac{x+y}{2}$	Q'	ГΥ						
				$0 \leq 0.25$		1	Accept					
10 LCD display			Ç	Ø>0.25		1	Accept					
Pin hole ——	Pin hole		noie		$\emptyset < \frac{1}{4} W$ $\emptyset > \frac{1}{4} W$			1				
						1	Reject	MIN				
	Draw		1	S	tandard	0===						
		Δ		$\frac{X}{\frac{1}{4}b}$	$\frac{y}{\geq \frac{1}{4}a}$	QTY 1	Reject	MIN				
LCD display	 					1	Dairet	MINT				
Broken segment(dots)	The state of the s		($X \text{ or } y) \ge 1$		1	Reject	MIN				
			≦	$\leq \frac{1}{4} b$	$\leq \frac{1}{4}a$	1	Accept					
				$\leq \frac{1}{5}b$	$\leq \frac{1}{5}a$	2	Accept					

Item		Inspection Standard Description						
		× ×		$\emptyset = \frac{x+y}{2}$	QTY			
	LCD display			Ø<0.10		Accept		
12	Black spot or		1	0.1<∅≤0.20	2	Accept		
	White spot		\rightarrow	0.20 \le \O < 0.25	1	Accept		
			•	$0.25 < \emptyset \le 0.4$		Reject	MIN	
				Ø>0.4	0	Reject	MAJ	
			Black line	/white line(L×w)mm	QTY			
				$\leq 1.0 \times (W \leq 0.025)$	2	Accept		
13	LCD display excess bl	ack line or white line	$\frac{(1.0 < L \le 1.5) \times (W \le - \cdot 0.025)}{(L > 1.5) \times (W \le 0.025)}$		1	Accept		
					0	Reject	MIN	
			(]	(L>2)×(W>0.025)		Reject	MAJ	
14	Backlight not function						MAJ	
15	LED not function or dim						MIN	
16	Backlight defect (dirt,	scratch)			·	Reject	MIN	

2) COSMETIC INSPECTION STANDARD

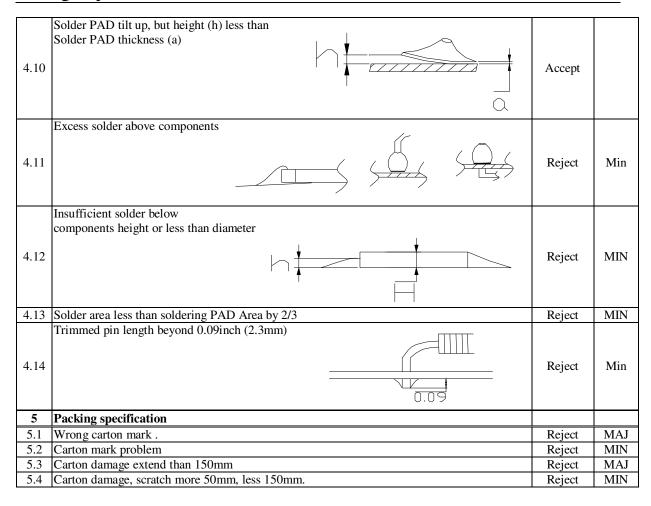
Item	Standard description of inspection						Defect type	
1	LCD inspection item							
1.1	LCD color variation					See	MIN	
						sample		
1.2	LCD broken		Reject Reject	MAJ MAJ				
		Wrong polarizer of LCD						
1.4	Spot on LCD surface Scratch on LCD X	Reject	MAJ					
	Scratch on LCD	_		Scratch = \emptyset	QTY	A4		
	x+y			Ø<0.1	Except	Accept		
1.5	$\emptyset = \frac{x+y}{2}$	₹ y		$0.1 \leq \emptyset \leq 0.15$	2	Accept		
	2 <u>- W</u>	<u> </u>		0.15< ø≤0.25	1	Accept	1.50.5	
	r an			Ø>0.25	1	Reject	MIN	
	LCD scratch	Scratch =L	SCI	ratch =W	QTY			
				W≦0.015		Accept		
1.6		< 0.5		$W \leq 0.02$	2	Accept		
	Scratch depth see sample	<1.0		$W \leq 0.03$	1	Accept		
	Seraten depth see sample	≥1.0	W≥0.03		1	Reject	MIN	
					QTY			
	White or black spot on LCD	-		Ø<0.1		Accept		
1.7	x + y			0.1 \le \O < 0.2	2	Accept		
1.7	$\emptyset = \frac{x+y}{2}$) >		$0.2 \le \emptyset \le 0.25$	1	Accept		
	_			Ø>0.25	1	Reject	MIN	
				Bevy point	-	Reject	MIN	
	Black line	(L)		(W)	QTY			
1.8	in LCD	L≦1.0		W≦0.025	2	Accept		
1.0		1.0<1≦1.	5	W≦0.025	1	Accept		
	-	1.5 <l< td=""><td></td><td>W>0.025</td><td>1</td><td>Reject</td><td>MIN</td></l<>		W>0.025	1	Reject	MIN	
				Size	QTY			
1.9	Round air bubble			Ø<0.15	2	Accept		
1.9	Koung an outble			$0.15 \le \emptyset \le 0.25$	1	Accept		
				Ø>0.25	0	Reject	MIN	
		(L)		(W)	QTY	_	· · ·	
1 10	Line defect	L<0.5		W<0.02	2	Accept		
1.10	Ellic delect	L<1.0		W<0.03	1	Accept		
		L≧1.0		W≧0.3	0	Reject	MIN	
1.11	Finger print					Reject	MIN	

Item	Standard description of inspection							Defect type
2	PCB/COB specification							
	PCB deformity	-		L		Н		
2.1	≤6.0 >6.0r <6.0r				n	≤1.5mm	Accept	
					1	≤1.5mm	Reject	MIN
					n	>1.5mm	Reject	MIN
		Τ.		>6.0mn		>1.5mm	Reject	MIN
2.2	Deformity at PCB edge, dam	Deformity at PCB edge, damage circuit.						
	/ // L					Н	Reject	
	Convex at PCB edge		≦6.0mi	≤6.0mm		Accept		
2.3				>6.0mm		≤1.5mm	Reject	MIN
					<6.0mm		Reject	MIN
	L ''				1	>1.5mm >1.5mm	Reject	MIN
2.4	Damage excess 2x2mm at th	e PCB corner	<u>_</u>				Reject	MIN
	Scratch on PCB surface	<u> </u>					See sample	MIN
	Scratch on PCB coat/leakage	coat on PCB surface					Reject	MAJ
	Open circuit						Reject	MAJ
	PCB PTH open						Reject	MAJ
	•				QTY	≤2PCS	Accept	
2.9	Repair PCB PTH $\frac{QTY \ge 3PCS}{QTY \ge 3PCS}$						Reject	MAJ
2.10	Color different from one side	e to another side.					Reject	MIN
	<30mm ²					Accept	1,111	
2.11	Repaired solder mask area $\frac{\leq 30 \text{mm}}{\geq 30 \text{mm}^2}$						Reject	MIN
	Scratch circuit, damage		1 1		=30		Reject	1/111 (
2.12	Circuit						Accept	
			w		a>1/2	2w or b>w	Reject	
3	Bezel specification				ı			
	Wrong Materials							MAJ
	Incorrect dimension							MAJ
3.3	Bezel broken						MAJ	
	Rust on Bezel							MA.
			Size		(cm²/per		
			Ø≦	0.3		2	Accept	
		Top surface	0.3<Ø	0≤0.5		1	Accept	
3.5	Hole or dirty on oil			>0.5		0	Reject	MIN
	Paint surface Side			$\emptyset \le 0.5$ $0.5 < \emptyset \le 0.8$		2	Accept	
						1	Accept	
	Side 0					0	Reject	MIN
			Ø>() () 1 r	nm/mm	Accept	14111
3.6	Rezel how or twict					nm/mm	Reject	MIN
3.7		d1 d2		d1-d2≦			Accept	Will
				d1-	d2>to	lerance	Reject	MIN

Item	Standard description of inspection	Standard	Defect

l [type
	Scratch on bezel		Face		Accept QTY		
	>		L	W	Not	See Sample	
			_	W≦0.15	defined		
			L≦3	W≦0.20	2		
			 L≦2	W ≦0.20 W≤0.3	2		
					2		
3.8			-	W>0.3	A .		
			side		Accept QTY		
		-	L W		QII		
		-	-	W≦0.2	except	See Sample	
		=	1 < 2		_		
		-	L≦3	W≦0.25	2		
			L≦2	W≦0.3	2		
		Δ°					
3.9	Twist angle α=45°+5°	<u> </u>				Accept	
		\	\				
3.10	Void gap between bezel and PCB					Reject	MIN
	Bezel clip incorrectly					Reject	IVIIIN
	Bezer on p moorreedy	A					
3.11							MIN
3.11						Reject	IVIIIN
		VZZ.	NG	à			
4			1.0				
4 .	Solder specification						
	Solder specification Wrong component					Reject	MAJ
4.1	Wrong component					Reject Reject	MAJ MAJ
4.1	Wrong component Broken component			d beyond the		Reject	MAJ MAJ
4.1	Wrong component Broken component			d beyond the			
4.1	Wrong component Broken component Mis-alignment	egs >pac	distance(w)	on solder are	$a > W^2$	Reject	
4.1	Wrong component Broken component Mis-alignment Co	egs >pac	d distance(w)	on solder are	a >W ²	Reject	
4.1	Wrong component Broken component Mis-alignment Co	egs >pac	d distance(w)	on solder are	a >W ²	Reject Accept	MAJ
4.1 4.2 4.3	Wrong component Broken component Mis-alignment Co	egs >pac compone egs >pac	nt legs extend distance(w)	on solder are d beyond the on solder are	$a > W^2$ pad and $a < W^2$	Reject Accept Reject	MAJ
4.1 4.2	Wrong component Broken component Mis-alignment Co Le Component So	egs >pac compone egs >pac	nt legs extend distance(w)	on solder are	$a > W^2$ pad and $a < W^2$	Reject Accept	MAJ
4.1 4.2	Wrong component Broken component Mis-alignment Contact Component Componen	egs >pac compone egs >pac older leg /4W	nt legs extend d distance(w) s offset dista	d beyond the on solder are	$a > W^2$ pad and $a < W^2$	Reject Accept Reject Accept	MAJ
4.1 4.2	Wrong component Broken component Mis-alignment Contact Component Componen	egs >pac compone egs >pac older leg /4W	nt legs extend distance(w)	d beyond the on solder are	$a > W^2$ pad and $a < W^2$	Reject Accept Reject	MAJ
4.1 4.2 4.3	Wrong component Broken component Mis-alignment Contact Component Componen	egs >pac compone egs >pac older leg /4W	nt legs extend d distance(w) s offset dista	d beyond the on solder are	$a > W^2$ pad and $a < W^2$	Reject Accept Reject Accept	MAJ
4.1 4.2 4.3	Wrong component Broken component Mis-alignment Contact Component Componen	egs >pac compone egs >pac older leg /4W	nt legs extend d distance(w) s offset dista	d beyond the on solder are	$a > W^2$ pad and $a < W^2$	Reject Accept Reject Accept	MAJ
4.1 4.2 4.3	Wrong component Broken component Mis-alignment Contact Component Componen	egs >pac compone egs >pac older leg /4W	d distance(w) nt legs extend distance(w) s offset dista	d beyond the on solder are	$a > W^2$ pad and $a < W^2$	Reject Accept Reject Accept	MAJ
4.1 4.2 4.3	Wrong component Broken component Mis-alignment Contact Component Componen	egs >pac compone egs >pac older leg /4W	d distance(w) nt legs extend distance(w) s offset dista	d beyond the on solder are	$a > W^2$ pad and $a < W^2$	Reject Accept Reject Accept Accept	MAJ MIN MIN
4.1 4.2 4.3 4.4	Wrong component Broken component Mis-alignment Contact Component Componen	egs >pac compone egs >pac older leg /4W	d distance(w) nt legs extend distance(w) s offset dista	d beyond the on solder are	$a > W^2$ pad and $a < W^2$	Reject Accept Reject Accept Reject Reject	MAJ MIN MIN
4.1 4.2 4.3 4.4 4.5	Wrong component Broken component Mis-alignment Contact Component Compon	egs >pac compone egs >pac older leg /4W	d distance(w) nt legs extend distance(w) s offset dista	d beyond the on solder are	$a > W^2$ pad and $a < W^2$	Reject Accept Reject Accept Reject Accept Accept Accept	MIN MIN
4.1 4.2 4.3 4.4 4.5 4.6	Wrong component Broken component Mis-alignment Component Comp	egs >pac compone egs >pac older leg /4W	d distance(w) nt legs extend distance(w) s offset dista	d beyond the on solder are	pad and a <w<sup>2 legs</w<sup>	Reject Accept Reject Accept Reject Accept Reject	MAJ MIN MIN
4.1 4.2 4.3 4.4 4.5 4.6	Wrong component Broken component Mis-alignment Contact Component Compon	egs >pac compone egs >pac older leg /4W	d distance(w) nt legs extend distance(w) s offset dista	d beyond the on solder are on	pad and a $<$ W ² legs	Reject Accept Reject Accept Reject Accept Reject Accept Accept Accept Accept Accept	MIN MIN MIN
4.1 4.2 4.3 4.4 4.5 4.6 4.7	Wrong component Broken component Mis-alignment Contact Component Component Offset Component assembly defect CHIP components hoist ≤0.5mm CHIP components hoist>0.5mm Components hoist	egs >pac compone egs >pac older leg /4W	d distance(w) nt legs extend distance(w) s offset dista	d beyond the on solder are on	pad and a $<$ W ² legs $1 \le 2.0 \text{mm}$ $1 > 2.0 \text{mm}$	Reject Accept Reject Accept Reject Accept Reject Accept Accept Reject Accept Reject	MIN MIN
4.1 4.2 4.3 4.4 4.5 4.6 4.7	Wrong component Broken component Mis-alignment Component Comp	egs >pac compone egs >pac older leg /4W	d distance(w) nt legs extend distance(w) s offset dista	on solder are d beyond the on solder are nnce L <solder 4w<="" td=""><td>pad and a $<$W² legs</td><td>Reject Accept Reject Accept Reject Accept Reject Accept Accept Accept Accept Accept</td><td>MIN MIN MIN</td></solder>	pad and a $<$ W ² legs	Reject Accept Reject Accept Reject Accept Reject Accept Accept Accept Accept Accept	MIN MIN MIN

Item	Standard description of inspection	Standard	Defect type



12. Precautions For Using LCD Modules

HANDLING PRECAUTIONS

- 1. This device is susceptible to Electro-Static Discharge (ESD) damage. Observe Anti-Static precautions.
- 2. The display panel is made of glass. Do not subject it to a mechanical shock by dropping it or impact.
- 3. If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.
- 4. Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- 5. The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- 6. If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents:
 - Isopropyl alcohol
 - Ethyl alcohol
- 7. Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the following.
 - Water
 - Ketone
 - Aromatic solvents
- 8. Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
- 9. Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.
- 10. Do not attempt to disassemble or process the LCD module.
- 11. NC terminal should be open. Do not connect anything.
- 12. If the logic circuit power is off, do not apply the input signals.

- 13. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - Be sure to ground the body when handling the LCD modules.
 - Tools required for assembling, such as soldering irons, must be properly grounded.
 - To reduce the amount of static electricity generated, do not conduct assembling and other work under dry
 conditions.
 - The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.

• POWER SUPPLY PRECAUTIONS:

- 1. Identify and, at all times, observe absolute maximum ratings for both logic and LC drivers. Note that there is some variance between models.
- 2. Prevent the application of reverse polarity to VDD and VSS, however briefly.
- 3. Use a clean power source free from transients. Power-up conditions are occasionally "jolting" and may exceed the maximum ratings of the modules.
- 4. The VDD power of the module should also supply the power to all devices that may access the display. Don't allow the data bus to be driven when the logic supply to the module is turned off.

• OPERATING PRECAUTIONS:

- 1. DO NOT plug or unplug the module when the system is powered up.
- 2. Minimize the cable length between the module and host MPU.
- 3. For models with EL backlights, do not disable the backlight by interrupting the HV line. Unload inverters produce voltage extremes that may are within a cable or at the display.
- 4. Operate the module within the limits of the modules temperature specifications.

• MECHANICAL/ENVIRONMENTAL PRECAUTIONS:

- 1. Improper soldering is the major cause of module difficulty. Use of flux cleaner is not recommended as they may seep under the elastomeric connection and cause display failure.
- 2. Mount the module so that it is free from torque and mechanical stress.
- 3. Surface of the LCD panel should not be touched or scratched. The display front surface is an easily scratched, plastic polarizer. Avoid contact and clean only when necessary with soft, absorbent cotton dampened with petroleum benzene.
- 4. Always employ anti-static procedure while handling the module.
- 5. Prevent moisture build-up upon the module and observe the environmental constraints for storage temperature and humidity.
- 6. Do not store in direct sunlight
- 7. If leakage of the liquid crystal material should occur, avoid contact with this material, particularly ingestion. If the body or clothing becomes contaminated by the liquid crystal material, wash thoroughly with water and soap

STORAGE PRECAUTIONS

When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps. Keep the
modules in bags (avoid high temperature / high humidity and low temperatures below specified storage
temperature). Whenever possible, the LCD modules should be stored in the same conditions in which they were
shipped from our company.

OTHERS

- 1. Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature.
- 2. If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.
- 3. To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.
 - Exposed area of the printed circuit board.
 - Terminal electrode sections.

13. Using LCD Modules

• Liquid Crystal Display Modules

LCD is composed of glass and polarizer. Pay attention to the following items when handling.

- Please keep the temperature within specified range for use and storage. Polarization degradation, bubble generation
 or polarizer peel-off may occur with high temperature and high humidity.
- 2. Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead (glass, tweezers, etc.).
- 3. N-hexane is recommended for cleaning the adhesives used to attach front/rear polarizers and reflectors made of organic substances which will be damaged by chemicals such as acetone, toluene, ethanol and isopropylalcohol.
- 4. When the display surface becomes dusty, wipe gently with absorbent cotton or other soft material like chamois soaked in petroleum benzin. Do not scrub hard to avoid damaging the display surface.
- 5. Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading.
- 6. Avoid contacting oil and fats.
- 7. Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizers. After products are tested at low temperature they must be warmed up in a container before coming is contacting with room temperature air.
- 8. Do not put or attach anything on the display area to avoid leaving marks on.
- 9. Do not touch the display with bare hands. This will stain the display area and degradate insulation between terminals (some cosmetics are determinated to the polarizers).
- As glass is fragile. It tends to become or chipped during handling especially on the edges. Please avoid dropping or jarring.

• Precaution for Handing LCD Modules

Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.

- 1. Do not alter, modify or change the shape of the tab on the metal frame.
- 2. Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.
- 3. Do not damage or modify the pattern writing on the printed circuit board.
- 4. Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector.
- 5. Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
- 6. Do not drop, bend or twist LCM.

Electro-Static Discharge Control

Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC.

- 1. Make certain that you are grounded when handing LCM.
- 2. Before remove LCM from its packing case or incorporating it into a set, be sure the module and your body have the same electric potential.
- 3. When soldering the terminal of LCM, make certain the AC power source for the soldering iron does not leak.
- 4. When using an electric screwdriver to attach LCM, the screwdriver should be of ground potentiality to minimize as much as possible any transmission of electromagnetic waves produced sparks coming from the commutator of the motor.
- 5. As far as possible make the electric potential of your work clothes and that of the work bench the ground potential.
- 6. To reduce the generation of static electricity, be careful that the air in the work is not too dried. A relative humidity of 50%-60% is recommended.

Precaution for soldering to the LCM

- 1. Observe the following when soldering lead wire, connector cable and etc. to the LCM.
 - Soldering iron temperature : 310° C $\pm 10^{\circ}$ C.
 - Soldering time: 3-4 sec.
 - Solder: lead free solder.

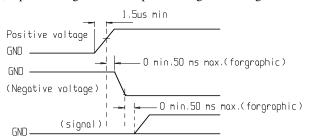
If soldering flux is used, be sure to remove any remaining flux after finishing to soldering operation. (This does not apply in the case of a non-halogen type of flux.) It is recommended that you protect the LCD surface with a cover during soldering to prevent any damage due to flux spatters.

- 2. When soldering the electroluminescent panel and PC board, the panel and board should not be detached more than three times. This maximum number is determined by the temperature and time conditions mentioned above, though there may be some variance depending on the temperature of the soldering iron.
- 3. When remove the electroluminescent panel from the PC board, be sure the solder has completely melted, the soldered pad on the PC board could be damaged.

Precautions for Operation

- 1. Viewing angle varies with the change of liquid crystal driving voltage (VO). Adjust VO to show the best contrast.
- 2. Driving the LCD in the voltage above the limit shortens its life.

- 3. Response time is greatly delayed at temperature below the operating temperature range. However, this does not mean the LCD will be out of the order. It will recover when it returns to the specified temperature range.
- 4. If the display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and then back on.
- 5. Condensation on terminals can cause an electrochemical reaction disrupting the terminal circuit. Therefore, it must be used under the relative condition of 40°C, 50% RH.
- 6. When turning the power on, input each signal after the positive/negative voltage becomes stable.



Storage

When storing LCDs as spares for some years, the following precaution are necessary.

- 1. Store them in a sealed polyethylene bag. If properly sealed, there is no need for dessicant.
- Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0°C and 35°C.
- 3. The polarizer surface should not come in contact with any other objects. (We advise you to store them in the container in which they were shipped.)
- 4. Environmental conditions:
 - Do not leave them for more than 168hrs. at 60°C.
 - Should not be left for more than 48hrs. at -20°C.

Safety

- 1. It is recommended to crush damaged or unnecessary LCDs into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.
- If any liquid leakes out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and water.

• Limited Warranty

Unless agreed between DISPLAYTECH and customer, DISPLAYTECH will replace or repair any of its LCD modules which are found to be functionally defective when inspected in accordance with DISPLAYTECH LCD acceptance standards (copies available upon request) for a period of one year from date of shipments. Cosmetic/visual defects must be returned to DISPLAYTECH within 90 days of shipment. Confirmation of such date shall be based on freight documents. The warranty liability of DISPLAYTECH limited to repair and/or replacement on the terms set forth above. DISPLAYTECH will not be responsible for any subsequent or consequential events.

• Return LCM under warranty

No warranty can be granted if the precautions stated above have been disregarded. The typical examples of violations are:

- Broken LCD glass.
- PCB eyelet's damaged or modified.
- PCB conductors damaged.
- Circuit modified in any way, including addition of components.
- PCB tampered with by grinding, engraving or painting varnish.
- soldering to or modifying the bezel in any manner.

Module repairs will be invoiced to the customer upon mutual agreement. Modules must be returned with sufficient description of the failures or defects. Any connectors or cable installed by the customer must be removed completely without damaging the PCB eyelet's, conductors and terminals.